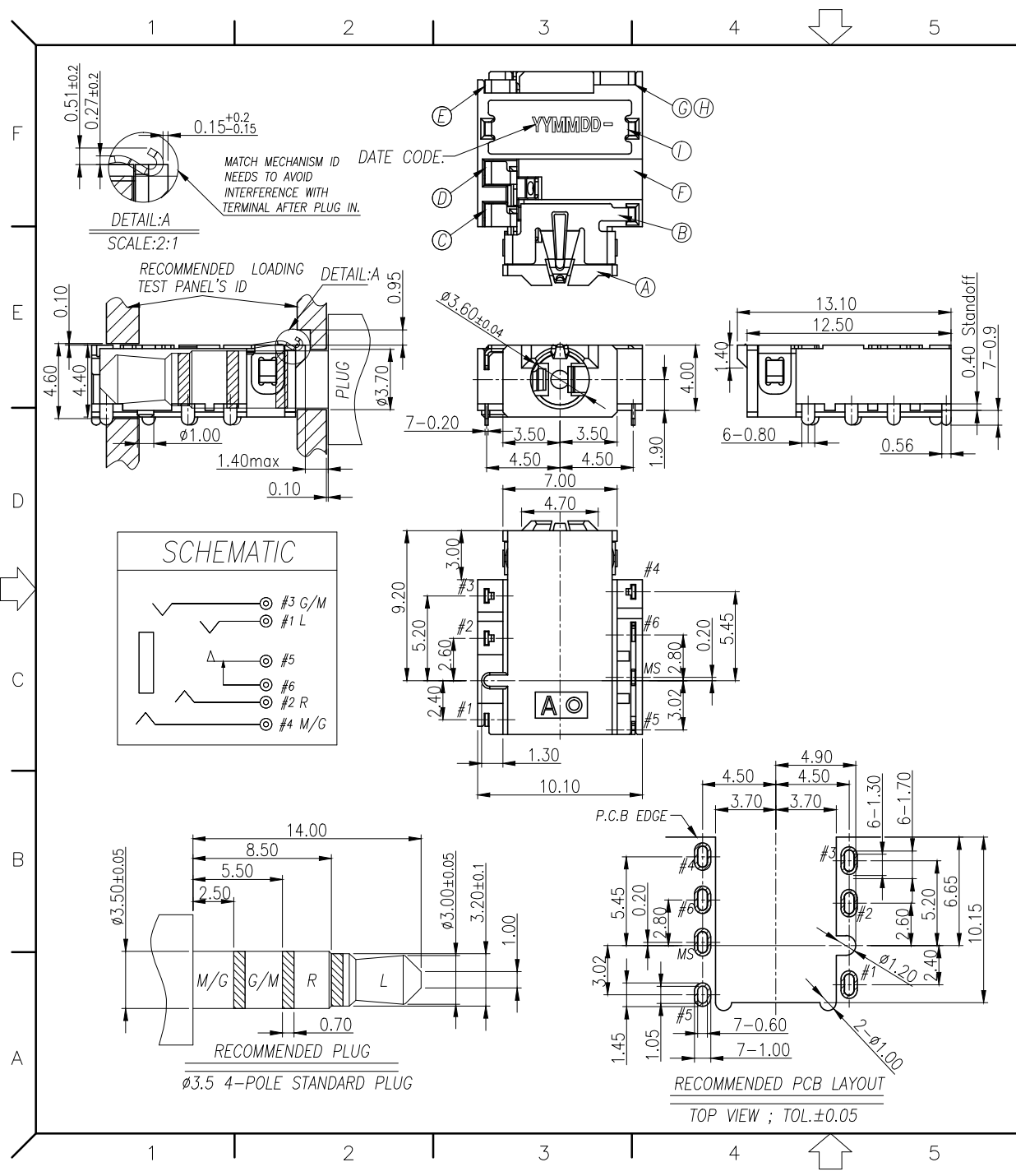


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PDR NO: T160907-1A	Yulin	2017.05.19



SPECIFICATIONS:

- INSULATION RESISTANCE BETWEEN ANY ADJACENT OPEN CIRCUIT TERMINAL SHELL NOT BE LESS THAN 100MΩ MEASURED BY 500 VDC.
- CONTACT RESISTANCE: 50mΩ MAX(INITIAL).
- INSULATION VOLTAGE WITHSTAND:500V AC FOR ONE MINUTE.
- UNLESS OTHERWISE SPECIFIED, TEST IS TO BE MADE AT 5-35°C IN TEMPERATURE AND 45-85% IN HUMIDITY. BUT,IF ANY VAGUE DATA IS OCCURED ON TEST RESULT, ANOTHER TEST SHALL BE MADE AT 20°C±2°C IN TEMP., 60-70% IN HUMIDITY.
- LIFE TEST: 5,000 CYCLES MIN.
- INSERTION FORCE: 0.3 - 3Kg.
- WITHDRAWAL FORCE: 0.3 - 3Kg.
- AFTER LIFE TEST, CONTACT RESISTANCE: 100mΩ MAX.
- AFTER HUMIDITY TEST, INSULATION RESISTANCE: 50MΩ MIN.
- PACKING : TAPE & REEL.
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT:
- HALOGEN FREE PRODUCT IDENTIFICATION LOGO ON PACKAGING:
- THE AUDIO JACK MUST BE IN THE AIR FULL OF NITROGEN DURING IR REFLOW PROCESS

I	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
I	SHELL	1	SUS 0.2t	Ni 60u"Min.
H	SEPARATOR	1	HIGH TEMP.THERMOPLASTIC UL 94V-0	BLACK
G	TRANSFER TERMINAL	1	COPPER ALLOY, 0.2t	GOLD FLASH ON CONTACT AREA; GOLD FLASH ON SOLDER AREA; ALL OVER 50u" Ni.
F	MAKE TERMINAL	1	COPPER ALLOY, 0.2t	GOLD FLASH ON CONTACT AREA; Matte Sn120u" ON SOLDER AREA; ALL OVER 50u" Ni.
E	TIP SPRING	1	COPPER ALLOY, 0.2t	
D	RING A	1	COPPER ALLOY, 0.2t	
C	RING B	1	COPPER ALLOY, 0.2t	
B	EARTH	1	COPPER ALLOY, 0.2t	
A	BODY	1	HIGH TEMP.THERMOPLASTIC UL 94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
UNLESS OTHERWISE SPECIFIED TOLERANCES		Singatron Enterprise Co., Ltd. 信音企業股份有限公司		
DECIMALS:	ANGLES:	TITLE	3.5Ø PHONE JACK	
X :±0.5	X :±2°	DWN	Yulin	PART NO.2SJ3108-086111F
X.X :±0.3	X.X :±1°	CHKD	Bruce	SCALE 4:1 UNIT: mm
X.XX :±0.2		APVD	Lussen	SIZE: A3 SHEET:1 OF 1 REV: A
CUSTOMER COPY				